



RFM products are now Murata products.

SF2204E

- 1900 MHz

3000 Pieces/Reel



SM3030-6

Low-loss SAW Filter

- Surface-mount 3.0 x 3.0 x 1.4 mm Package
- Complies with Directive 2002/95/EC (RoHS)

Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	10	dBm
DC Voltage on any Non-ground Terminal	3	V
Operating Temperature Range	-20 to +70	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Solder Reflow Temperature, 10 seconds, 5 cycles maximum	260	°C

Electrical Characteristics

				-		
Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency	F _C			1900		MHz
Insertion Loss, 1880 to 1920 MHz	IL			2.7	3.5	dB
Amplitude Ripple, 1880 to 1920 MHz				1.0	1.5	dB _{P-P}
Group Delay Ripple, 1880 to 1920 MHz				10	40	ns _{P-P}
Input VSWR, 1880 to 1920 MHz				1.5:1	2.0:1	
Output VSWR, 1880 to 1920 MHz				1.5:1	2.0:1	
Attenuation Referenced to 0 dB						
0.3 to 1000 MHz			30	35		
1000 to 1700 MHz			30	35		7
1700 to 1830 MHz			32	38		dB
1970 to 2400 MHz			38	45		dB
2400 to 3000 MHz			30	40		
3000 to 4000 MHz			25	34		7
Source Impedance	Z _S			50		0
Load Impedance	Z_{L}			50		Ω
Case Style		SM3	030-6 3.0 x 3.	.0 mm Nominal	Footprint	
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	936, YWWS					
Standard Reel Quantity Reel Size 7 Inch	500 Pieces/Reel					
	_					

Electrical Connections

Connection	Terminals
Input	5
Output	2
Ground	All Others

Reel Size 13 Inch

CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
- Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.

 Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance Rejection is measured as attenuation below the minimum it point in the passband. Rejection is measured as attenuation below the minimum it point in the passband. Rejection is design. See Application Note No. 42 for details.

 "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."

 The design, manufacturing process, and specifications of this filter are subject to change.

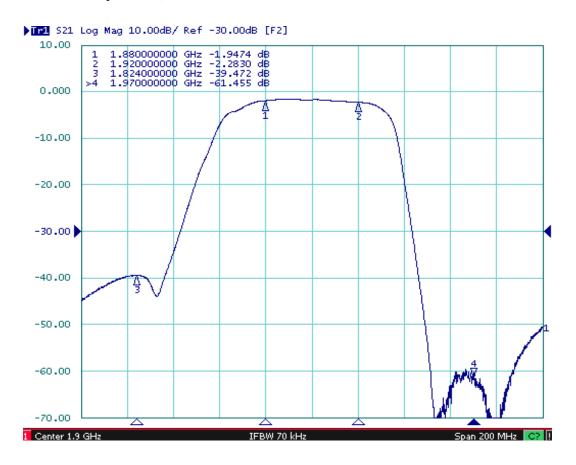
 Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that

the filter must always be installed in one direction per the circuit design.

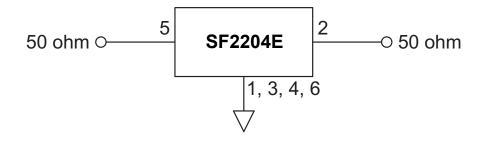
US and international patents may apply.

Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

Filter Passband Response, 1800 to 2000 MHz



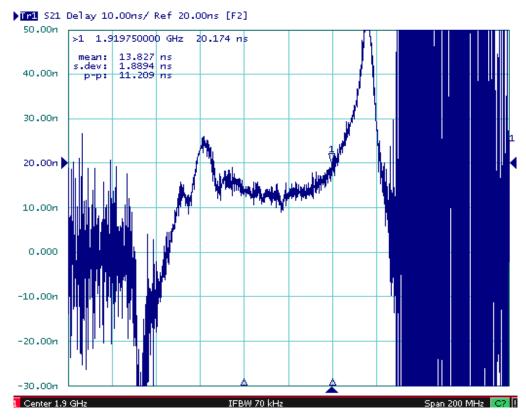
Filter Test Circuit



Filter Broadband Response, 300 kHz to 4000 MHz

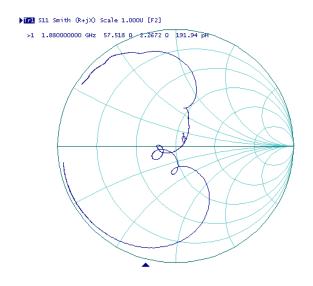


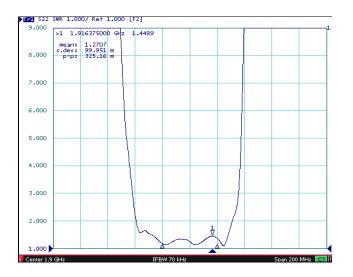
Filter Group Delay Plot, 1800 to 2000 MHz

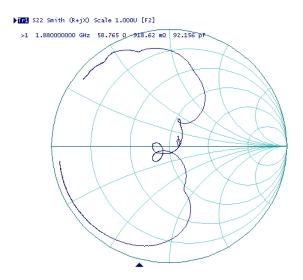


Input and Output VSWR Plots



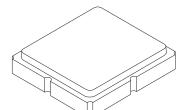


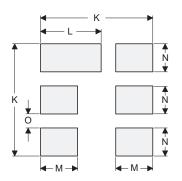




SM3030-6 Case

6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint





PCB Footprint Top View

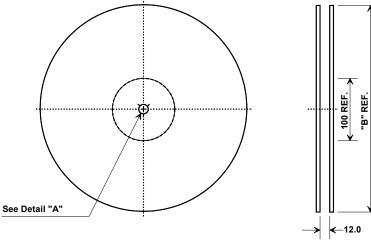
Case and PCB Footprint Dimensions

Dimension	mm			Inches			
Difficusion	Min	Nom	Max	Min	Nom	Max	
Α	2.87	3.00	3.13	0.113	0.118	0.123	
В	2.87	3.00	3.13	0.113	0.118	0.123	
С	1.12	1.25	1.38	0.044	0.049	0.054	
D	0.77	0.90	1.03	0.030	0.035	0.040	
E	2.67	2.80	2.93	0.105	0.110	0.115	
F	1.47	1.60	1.73	0.058	0.063	0.068	
G	0.72	0.85	0.98	0.028	0.033	0.038	
Н	1.37	1.50	1.63	0.054	0.059	0.064	
ı	0.47	0.60	0.73	0.019	0.024	0.029	
J	1.17	1.30	1.43	0.046	0.051	0.056	
K		3.20			0.126		
L		1.70			0.067		
М		1.05			0.041		
N		0.81			0.032		
0		0.38			0.015		

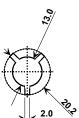
Case Materials

Materials				
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel			
Lid Plating	2.0 to 3.0 µm Nickel			
Body	Al ₂ O ₃ Ceramic			
Pb Free				

Tape and Reel Specifications

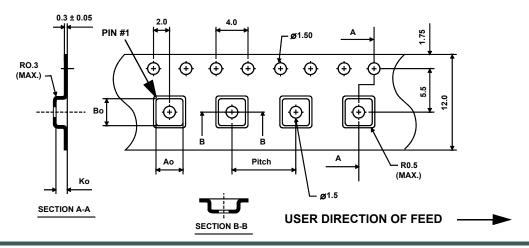


"B"		Quantity Per Reel	
Inches	millimeters		
7	178	500	
13	330	3000	



COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	3.35 mm
Во	3.35 mm
Ko	1.40 mm
Pitch	8.0 mm
W	12.0 mm



Typical Solder Reflow Profile

